

DATA SHEET

MC145406

EIA-232-D/V.28 driver/receiver

Product specification

1994 Aug 31

IC19 Data Handbook

EIA-232-D/V.28 driver/receiver

MC145406

DESCRIPTION

The MC145406 is a silicon-gate CMOS IC that combines 3 drivers and 3 receivers to fulfill the electrical specifications of standards EIA-232-D and CCITT V.28. The drivers feature true TTL input compatibility, slew-rate limited output, 300Ω power-off source impedance, and output typically switching to within 25% of the supply rails. The receivers can handle up to $\pm 25V$ while presenting 3 to $7k\Omega$ impedance. Hysteresis in the receiver aids reception of noisy signals. By combining both drivers and receivers in a single CMOS chip, the MC145406 provides efficient, low-power solutions for EIA-232-D and V.28 applications.

APPLICATIONS

- Modem interface
- Voice/data telephone interface
- Lap-top computers
- UART interface

FEATURES

- Drivers
- ± 5 to $\pm 12V$ supply range
- 300Ω power-off source impedance
- Output current limiting
- TTL compatible

PIN CONFIGURATION

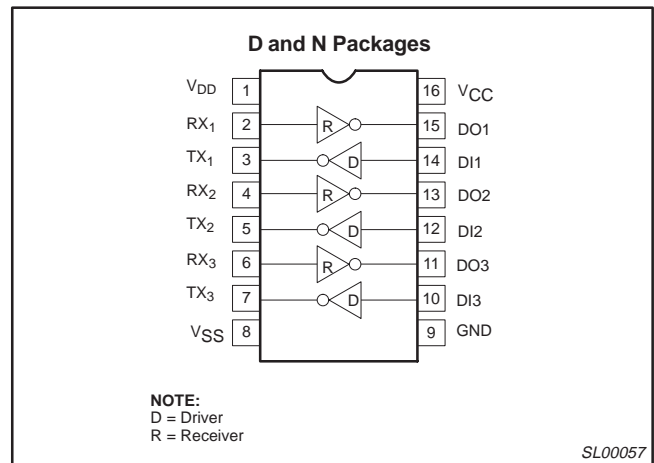


Figure 1. Pin Configuration

- Maximum slew rate = $30V/\mu s$
- Receivers
- $\pm 25V$ input voltage range over the full supply range
- 3 to $7k\Omega$ input impedance
- Hysteresis on input switchpoint
- General
- Very low supply currents for long battery life
- Operation is independent of power supply sequencing

ORDERING INFORMATION

DESCRIPTION	TEMPERATURE RANGE	ORDER CODE	DWG #
16-Pin Plastic Dual In-Line (DIP) Package	0 to $+70^{\circ}C$	MC145406N	SOT38-4
16-Pin Small Outline Large (SOL) Package	0 to $+70^{\circ}C$	MC145406D	SOT162-1

ABSOLUTE MAXIMUM RATINGS

SYMBOL	PARAMETER	RATING	UNITS
V _{CC}	Supply voltage	-0.5 to +6.0	V
V _{DD}	Supply voltage	-0.5 to +13.5	V
V _{SS}	Supply voltage	+0.5 to -13.5	V
V _{IR}	Input voltage range RX ₁₋₃ inputs DI ₁₋₃ inputs	(V _{SS} - 15) to (V _{DD} + 15) -0.5 to (V _{CC} + 0.5)	V
	DC current per pin	± 100	mA
P _D	Power dissipation (package)	1.0	W
T _A	Operating temperature range	0 to $+70$	$^{\circ}C$
T _{STG}	Storage temperature range	-65 to +150	$^{\circ}C$
θ_{JA}	Thermal impedance N package D package	80 105	$^{\circ}C/W$

NOTE: This device contains protection circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit. For proper operation, it is recommended that the voltages at the DI and DO pins be constrained to the range $GND \leq V_{DI} \leq V_{DD}$ and $GND \leq V_{DO} \leq V_{CC}$. Also, the voltage at the RX pin should be constrained to $\pm 25V$, and TX should be constrained to $V_{SS} \leq V_{TX1-3} \leq V_{DD}$. Unused inputs must always be tied to an appropriate logic voltage level (e.g., GND or V_{CC} for DI, and V_{SS} or V_{DD} for RX).

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BLOCK DIAGRAM

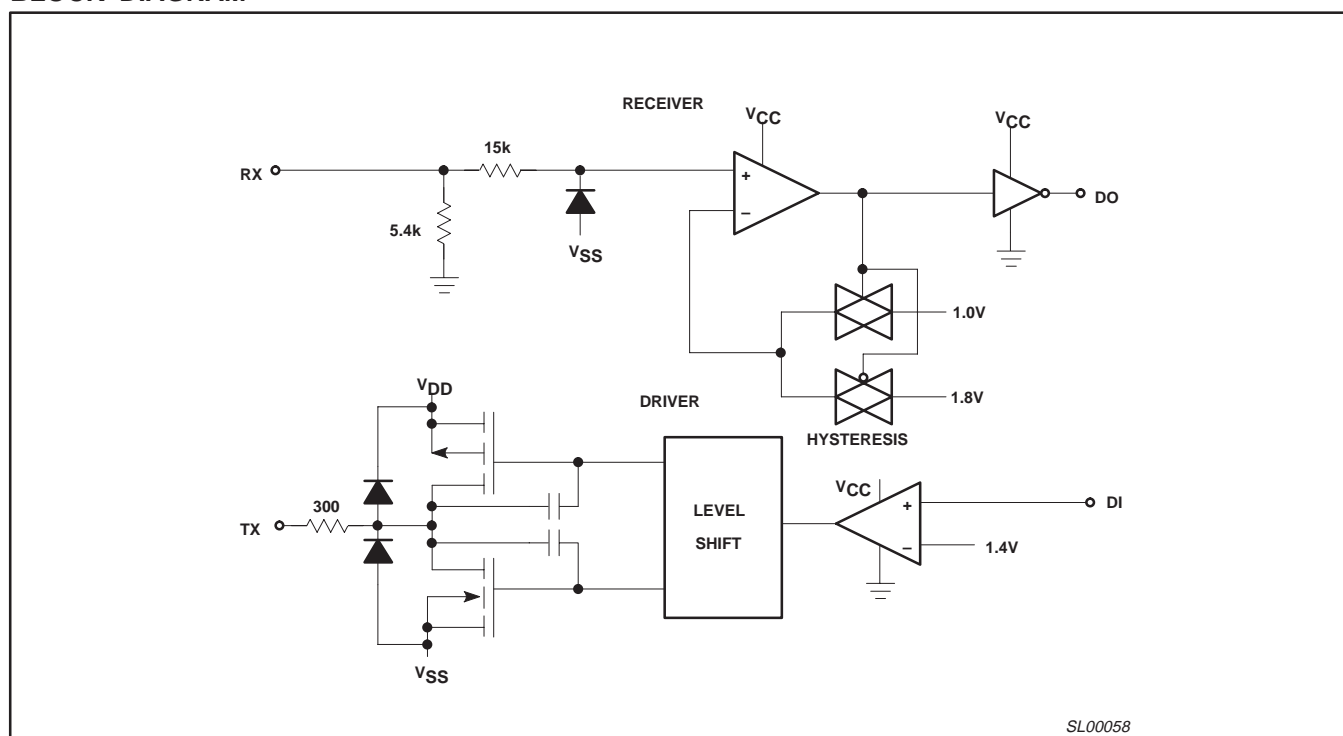


Figure 2. Block Diagram

PIN #	SYMBOL	PIN DESCRIPTION
1	V _{DD}	Positive power supply. The most positive power supply pin, which is typically 5 to 12 volts.
8	V _{SS}	Negative power supply. The most negative power supply pin, which is typically -5 to -12 volts.
16	V _{CC}	Digital power supply. The digital supply pin, which is connected to the logic power supply (maximum +5.5V).
9	GND	Ground. Ground return pin is typically connected to the signal ground pin of the EIA-232-D connector (Pin 7) as well as to the logic power supply ground.
2, 4, 6	RX ₁ , RX ₂ , RX ₃	Receive Data Input. These are the EIA-232-D receive signal inputs whose voltages can range from +25 to -25V. A voltage between +3 and +25 is decoded as a space and causes the corresponding DO pin to swing to ground (0V); a voltage between -3 and -25V is decoded as a mark and causes the DO pin to swing up to V _{CC} . The actual turn-on input switchpoint is typically biased at 1.8V above ground, and includes 800mV of hysteresis for noise rejection. The nominal input impedance is 5kΩ. An open or grounded input pin is interpreted as a mark, forcing the DO pin to V _{CC} .
11, 13, 15	DO1, DO2, DO3	Data Output. These are the receiver digital output pins, which swing from V _{CC} to GND. A space on the RX pin causes DO to produce a logic zero; a mark produces a logic one. Each output pin is capable of driving one LSTTL input load.
10, 12, 14	DI1, DI2, DI3	Data Input. These are the high-impedance digital input pins to the drivers. TTL compatibility is accomplished by biasing the input switchpoint at 1.4V above ground. However, 5V CMOS compatibility is maintained as well. Input voltage levels on these pins must be between V _{CC} and GND.
3, 5, 7	TX1, TX2, TX3	Transmit Data Output. These are the EIA-232-D transmit signal output pins, which swing toward V _{DD} and V _{SS} . A logic one at a DI input causes the corresponding TX output to swing toward V _{SS} . A logic zero causes the output to swing toward V _{DD} (the output voltages will be slightly less than V _{DD} or V _{SS} depending upon the output load). Output slew rates are limited to a maximum of 30V/μs. When the MC145406 is off (V _{DD} = V _{SS} = V _{CC} = GND), the minimum output impedance is 300Ω.

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ABSOLUTE MAXIMUM RATINGS

SYMBOL	PARAMETER	RATING	UNITS
V_{CC}	Supply voltage	-0.5 to +6.0	V
V_{DD}	Supply voltage	-0.5 to +13.5	V
V_{SS}	Supply voltage	+0.5 to -13.5	V
V_{IR}	Input voltage range RX ₁₋₃ inputs DI ₁₋₃ inputs	($V_{SS} - 15$) to ($V_{DD} + 15$) -0.5 to ($V_{CC} + 0.5$)	V
	DC current per pin	±100	mA
P_D	Power dissipation (package)	1.0	W
T_A	Operating temperature range	0 to +70	°C
T_{STG}	Storage temperature range	-65 to +150	°C
θ_{JA}	Thermal impedance N package D package	80 105	°C/W

NOTE: This device contains protection circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit. For proper operation, it is recommended that the voltages at the DI and DO pins be constrained to the range $GND \leq V_{DI} \leq V_{DD}$ and $GND \leq V_{DO} \leq V_{CC}$. Also, the voltage at the RX pin should be constrained to $\pm 25V$, and TX should be constrained to $V_{SS} \leq V_{TX1-3} \leq V_{DD}$. Unused inputs must always be tied to an appropriate logic voltage level (e.g., GND or V_{CC} for DI, and V_{SS} or V_{DD} for RX).

DC ELECTRICAL CHARACTERISTICS

Typical values are at $T_A = 0$ to 70°C ; GND = 0V, unless otherwise specified.

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS			UNITS
			MIN	TYP	MAX	
DC supply voltage						
V _{DD}			4.5	5 to 12	13.2	V
V _{SS}			-4.5	-5 to -12	-13.2	V
V _{CC}			4.5	5.0	5.5	V
Quiescent supply current (outputs unloaded, inputs low)						
I _{DD}		V _{DD} = +12V		20	400	μA
I _{SS}		V _{SS} = -12V		280	600	μA
I _{CC}		V _{CC} = +5V		260	450	μA

RECEIVER ELECTRICAL CHARACTERISTICS

Typical values are at $T_A = 0$ to 70°C ; GND = 0V; $V_{DD} = +5$ to $+12V$; $V_{SS} = -5$ to $-12V$; $V_{CC} = +5V \pm 5\%$, unless otherwise specified.

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS			UNITS
			MIN	TYP	MAX	
V_{ON}	Input turn-on threshold	RX ₁₋₃ $V_{DO1-3} = V_{OL}$, $V_{CC} = 5.0V \pm 5\%$	1.35	1.80	2.35	V
V_{OFF}	Input turn-off threshold	RX ₁₋₃ $V_{DO1-3} = V_{OH}$, $V_{CC} = 5.0V \pm 5\%$	0.75	1.00	1.25	V
$V_{ON}-V_{OFF}$	Input threshold hysteresis	RX ₁₋₃ $V_{CC} = 5.0V \pm 5\%$	0.6	0.8		V
R_{IN}	Input resistance	RX ₁₋₃ $(V_{SS}-15V) \leq V_{RX1-3} \leq (V_{DD}+15V)$	3.0	5.0	7.0	kΩ
V_{OH}	High level output voltage	DO ₁₋₃ $I_{OH} = -20\mu A$, $V_{CC} = +5.0V$	4.9	5.0		V
	$V_{RX1-3} = -3V$ to $(V_{SS}-15V)$ ¹	$I_{OH} = -1mA$, $V_{CC} = +5.0V$	3.8	4.4		
V_{OL}	Low level output voltage	DO ₁₋₃ $I_{OL} = +20\mu A$, $V_{CC} = +5.0V$		0.005	0.1	V
	$V_{RX1-3} = +3V$ to $(V_{DD}+15V)$ ¹	$I_{OL} = +2mA$, $V_{CC} = +5.0V$		0.15	0.5	
		$I_{OL} = +4mA$, $V_{CC} = +5.0V$		0.3	0.7	

NOTE:

1. This is the range of input voltages as specified by EIA-232-D to cause a receiver to be in the high or low logic state.

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DRIVER ELECTRICAL CHARACTERISTICS

Typical values are at $T_A = 0$ to 70°C ; $GND = 0V$; $V_{CC} = +5V \pm 5\%$, unless otherwise specified.

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS			UNITS
			MIN	TYP	MAX	
V_{IL}	Digital input voltage DI_{1-3}	Logic 0			0.8	V
V_{IH}	Digital input voltage DI_{1-3}	Logic 1	2.0			V
I_{IN}	Input current DI_{1-3}	$V_{DI1-3} = V_{CC}$			± 1.0	μA
V_{OH}	Output high voltage TX_{1-3} $V_{DI1-3} = \text{Logic 0}, R_L = 3.0k\Omega$	$V_{DD} = +5.0V, V_{SS} = -5.0V$	3.5	4.1		V
		$V_{DD} = +6.0V, V_{SS} = -6.0V$	4.3	5.0		
		$V_{DD} = +12.0V, V_{SS} = -12.0V$	9.2	10.4		
V_{OL}	Output low voltage ¹ TX_{1-3} $V_{DI1-3} = \text{Logic 0}, R_L = 3.0k\Omega$	$V_{DD} = +5.0V, V_{SS} = -5.0V$	-4.0	-4.3		V
		$V_{DD} = +6.0V, V_{SS} = -6.0V$	-4.5	-5.2		
		$V_{DD} = +12.0V, V_{SS} = -12.0V$	-10.0	-10.3		
	Off source resistance TX_{1-3} Figure 3	$V_{DD}=V_{SS}=GND=0V, V_{TX1-3} = \pm 2.0V$	300			Ω
I_{SC}	Output short-circuit current TX_{1-3} $V_{DD} = +12.0V, V_{SS} = -12.0V$	TX_{1-3} shorted to GND^2		± 22	± 60	mA
		TX_{1-3} shorted to $\pm 15.0V^3$		± 60	± 100	mA

NOTE:

1. The voltage specifications are in terms of absolute values.
2. Specification is for one TX output pin to be shorted at a time. Should all three driver outputs be shorted simultaneously, device power dissipation limits will be exceeded.
3. This condition could exceed package limitations.

SWITCHING CHARACTERISTICS

Typical values are at $T_A = 0$ to 70°C ; $V_{CC} = +5V \pm 5\%$, unless otherwise specified. (See Figures 4 and 5)

SYMBOL	PARAMETER		TEST CONDITIONS	LIMITS			UNITS
				MIN	TYP	MAX	
Drivers							
t _{PLH}	Propagation delay time	TX ₁₋₃	Low-to-High R _L = 3kΩ, C _L = 50pF		300	500	ns
t _{PHL}	Propagation delay time	TX ₁₋₃	High-to-Low R _L = 3kΩ, C _L = 50pF		300	500	ns
SR	Output slew rate (minimum load)	TX ₁₋₃	R _L = 7kΩ, C _L = 0pF, V _{DD} = 6 to 12.0V, V _{SS} = -6 to -12V		±6	±30	V/μs
	Output slew rate (maximum load)	TX ₁₋₃	R _L = 3kΩ, C _L = 2500pF, V _{DD} = 12V, V _{SS} = -12V		±3.0		
Receivers (C _L = 50pF)							
t _{PLH}	Propagation delay time	DO ₁₋₃	Low-to-High		150	425	ns
t _{PHL}	Propagation delay time	DO ₁₋₃	High-to-Low		150	425	ns
t _R	Output rise time	DO ₁₋₃			120	400	ns
t _F	Output fall time	DO ₁₋₃			40	100	ns

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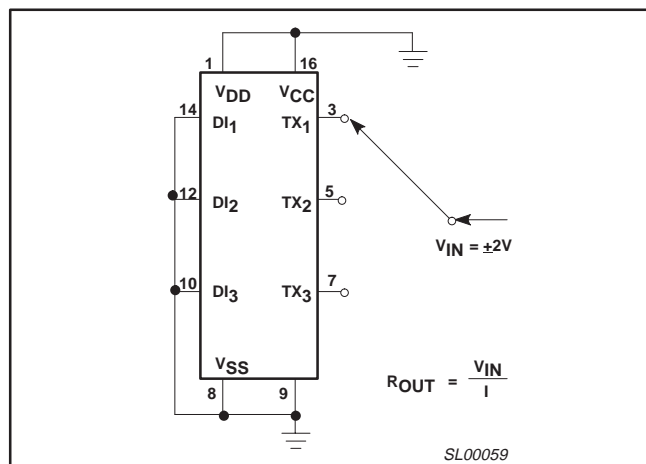


Figure 3. Power-Off Source Resistance (Drivers)

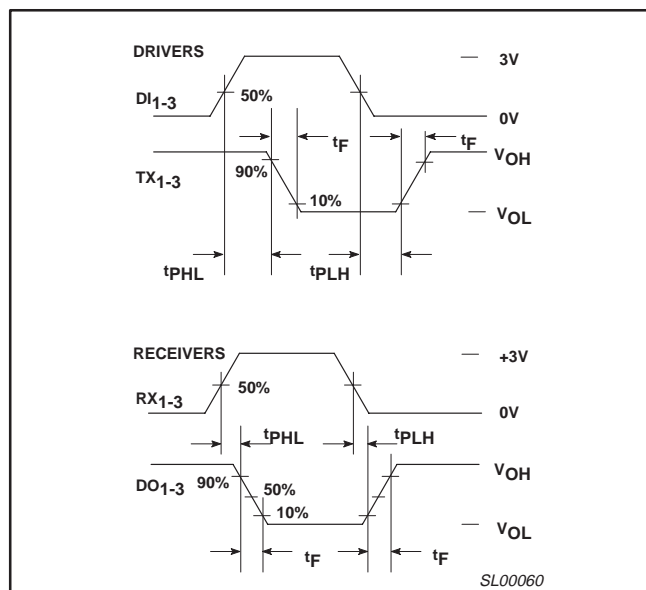


Figure 4. Switching Characteristics

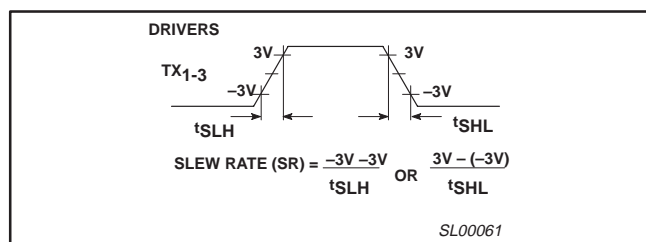


Figure 5. Slew Rate Characteristics

APPLICATIONS INFORMATION

The MC145406 has been designed to meet the electrical specifications of standards EIA-232-D/CCITT V.28 and as such, defines the electrical and physical interface between Data Communication Equipment (DCE) and Data Terminal Equipment (DTE). A DCE is connected to a DTE using a cable that typically carries up to 25 leads, which allow the transfer of timing, data, control, and test signals. The MC145406 provides the necessary level shifting between the TTL/CMOS logic levels and the high voltage levels of EIA-232-D (ranging from ± 3 to ± 25 V).

DRIVERS

As defined by the specification, an EIA-232-D driver presents a voltage of between ± 5 to ± 15 V into a load of between 3 to 7k Ω . A logic one at the driver input results in a voltage of between -5 to -15V. A logic zero results in a voltage between ± 5 to ± 15 V. When operating at ± 7 to ± 12 V, the MC145406 meets this requirement. When operating at ± 5 V, the MC145406 drivers produce less than ± 5 V at the output (when terminated), which does not meet the EIA-232-D specification. However, the output voltages when using a ± 5 V power supply are high enough (around ± 4 V) to permit proper reception by an EIA-232-D receiver, and can be used in applications where strict compliance to EIA-232-D is not required.

Another requirement of the MC145406 drivers is that they withstand a short to another driver in the EIA-232-D cable. The worst-case condition that is permitted by EIA-232-D is a ± 15 V source that is current limited to 500mA. The MC145406 drivers can withstand this condition momentarily. In most short circuit conditions the source driver will have a series 300 Ω output impedance needed to satisfy the EIA-232-D driver requirements. This will reduce the short circuit current to under 40mA which is an acceptable level for the MC145406 to withstand.

Unlike some other drivers, the MC145406 drivers feature an internally-limited output slew rate that does not exceed 30V/ μ s.

RECEIVERS

The job of an EIA-232-D receiver is to level-shift voltages in the range of -25 to +25V down to TTL/CMOS logic levels (0 to +5V). A voltage of between -3 and -25V on RX₁ is defined as a mark and produces a logic one at DO₁. A voltage between +3 and +25V is a space and produces a logic zero. While receiving these signals, the RX inputs must present a resistance between 3 and 7k Ω . Nominally, the input resistance of the RX₁₋₃ inputs is 5.0k Ω .

The input threshold of the RX₁₋₃ inputs is typically biased at 1.8V above ground (GND) with typically 800mV of hysteresis included to improve noise immunity. The 1.8V bias forces the appropriate DO pin to a logic one when its RX input is open or grounded as called for in EIA-232-D specification. Notice that TTL logic levels can be applied to the RX inputs in lieu of normal EIA-232-D signal levels. This might be helpful in situations where access to the modem or computer through the EIA-232-D connector is necessary with TTL devices. However, it is important not to connect the EIA-232-D outputs (TX₁) to TTL inputs since TTL operates off +5V only, and may be damaged by the high output voltage of the MC145406.

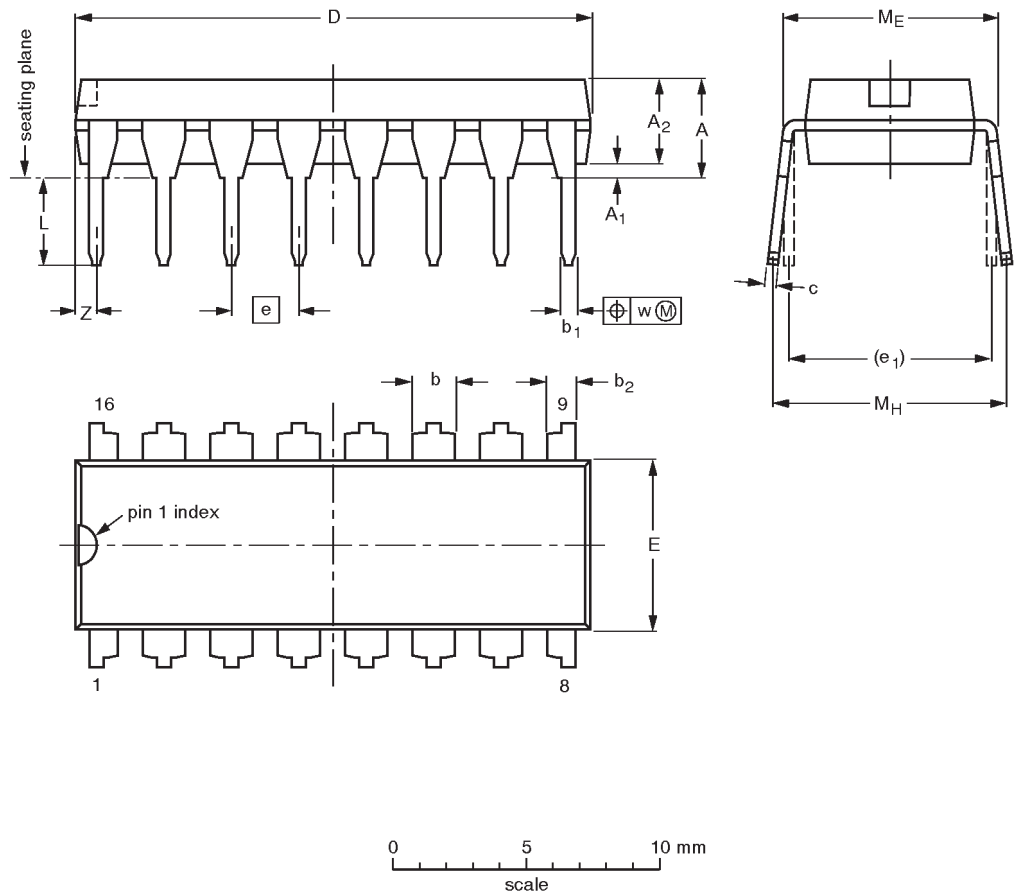
The DO outputs are to be connected to a TTL or CMOS input (such as an input to a modem chip). These outputs will swing from V_{CC} to ground, allowing the designer to operate the DO and DI pins from the digital power supply. The TX and RX sections are independently powered by V_{DD} and V_{SS} so that one may run logic at +5V and the EIA-232-D signals at ± 12 V.

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DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4




DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	b ₂	c	D ⁽¹⁾	E ⁽¹⁾	e	e ₁	L	M _E	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

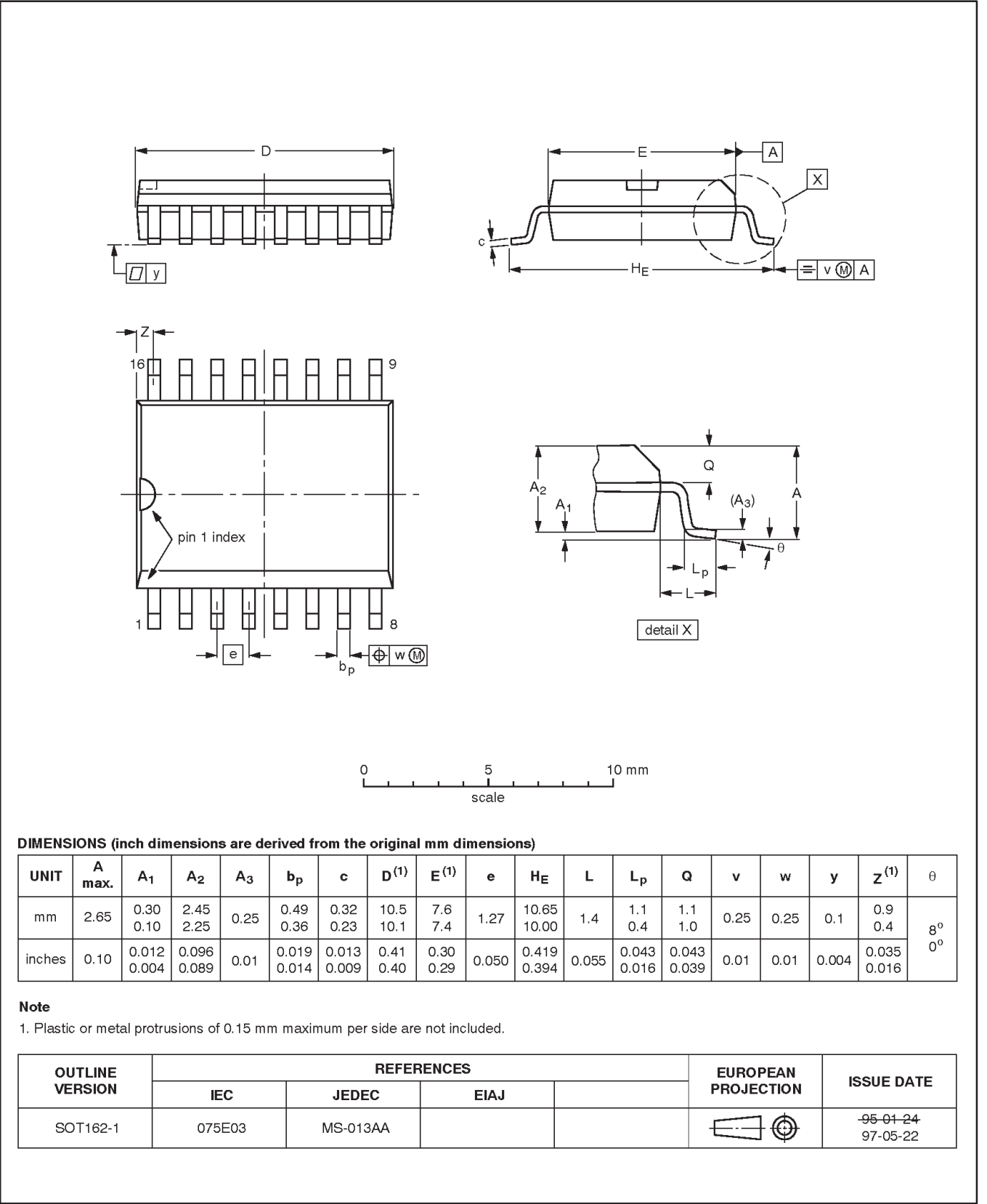
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT38-4						92-11-17 95-01-14

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SO16: plastic small outline package; 16 leads; body width 7.5 mm

SOT162-1



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NOTES

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Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
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[1] Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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